

UNISONIC TECHNOLOGIES CO., LTD

3N65-TA Power MOSFET

3A, 650V N-CHANNEL **POWER MOSFET**

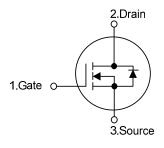
DESCRIPTION

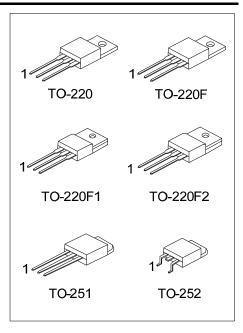
The UTC 3N65-TA is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)}$ < 3.5 Ω @ V_{GS} =10V, I_{D} =1.5A
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

SYMBOL

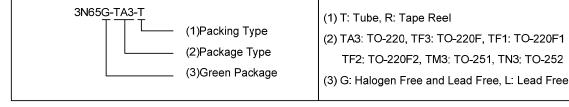




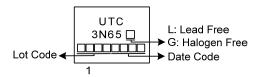
ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Packing	
Lead Free	Halogen Free	Package	1	2	3	i acking	
3N65L-TA3-T	3N65G-TA3-T	TO-220	G	D	S	Tube	
3N65L-TF1-T	3N65G-TF1-T	TO-220F1	G	D	S	Tube	
3N65L-TF2-T	3N65G-TF2-T	TO-220F2	G	D	S	Tube	
3N65L-TF3-T	3N65G-TF3-T	TO-220F	G	D	S	Tube	
3N65L-TM3-T	3N65G-TM3-T	TO-251	G	D	S	Tube	
3N65L-TN3-R	3N65G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



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■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

DADAMETED		CVMDOL	DATINGS	LINUT
PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	±30	V
Continuous Drain Current		I_{D}	3	Α
Pulsed Drain Current (Note 2)		I _{DM}	6	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	122	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.3	V/ns
Power Dissipation	TO-220		75	W
	TO-220F/TO-220F1 TO-220F2	P _D	34	W
	TO-251/TO-252		45	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH, I_{AS} = 4.94A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 3.0$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	θ_{JA}	62.5	°C/W
	TO-251/TO-252		110	°C/W
Junction to Case	TO-220		1.67	°C/W
	TO-220F/TO-220F1 TO-220F2	θ_{JC}	3.68	°C/W
	TO-251/TO-252		2.5	°C/W

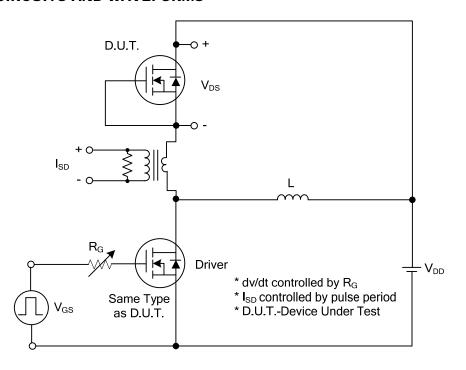
■ **ELECTRICAL CHARACTERISTICS** (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	650			V		
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 650V, V _{GS} = 0V			10	μA		
Gate- Source Leakage Current	Forward	」,	$V_{GS} = 30V, V_{DS} = 0V$			100	nA		
	Reverse	I_{GSS}	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10V, I_D = 1.5A$			3.5	Ω		
DYNAMIC CHARACTERISTICS							_		
Input Capacitance	put Capacitance				396		pF		
Output Capacitance	Output Capacitance		V _{DS} =25V, V _{GS} =0V, f=1.0MHz		45		рF		
Reverse Transfer Capacitance		C _{RSS}			3.2		pF		
SWITCHING CHARACTERISTICS	6						_		
Total Gate Charge (Note 1)		Q_G	V _{DS} =100V, V _{GS} =10V, I _D =2.0A		9.3		nC		
Gate-Source Charge		Q_GS	I_{G} =1mA (Note 1, 2)		2.7		nC		
Gate-Drain Charge		Q_GD	IG-IIIA (Note 1, 2)		2.1		nC		
Turn-On Delay Time (Note 1)		$t_{D(ON)}$			30		ns		
Turn-On Rise Time		t _R	V_{DS} =30V, V_{GS} =10V, I_{D} =0.5A, R_{G} =25 Ω (Note 1, 2)		22		ns		
Turn-Off Delay Time		t _{D(OFF)}			104		ns		
Turn-Off Fall Time		t_{F}			50		ns		
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS									
Maximum Body-Diode Continuous Current		Is				3	Α		
Maximum Body-Diode Pulsed Current		I _{SM}				6	Α		
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I_S =3.0A , V_{GS} =0V			1.4	V		
Reverse Recovery Time (Note 1)		t _{rr}	I_S =3.0A , V_{GS} =0V		248		ns		
Reverse Recovery Charge		Qrr	di/dt=100A/μs 1.		1.6		μC		

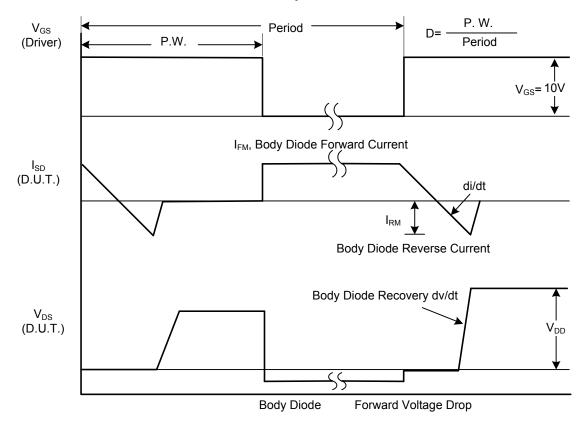
Notes: 1. Pulse Test: Pulse width \leq 300 μ s, Duty cycle \leq 2%.

^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



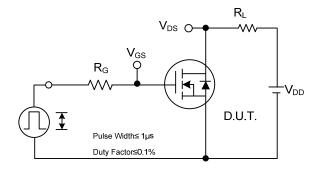
Peak Diode Recovery dv/dt Test Circuit

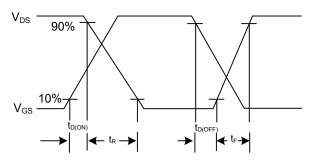


Peak Diode Recovery dv/dt Waveforms

3N65-TA Power MOSFET

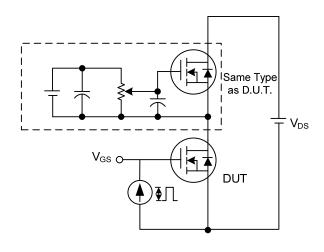
■ TEST CIRCUITS AND WAVEFORMS

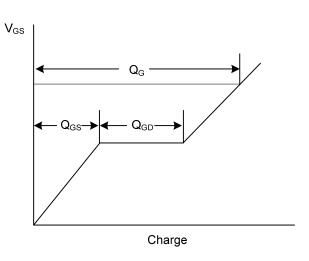




Switching Test Circuit

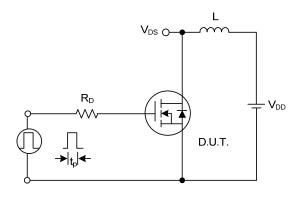
Switching Waveforms

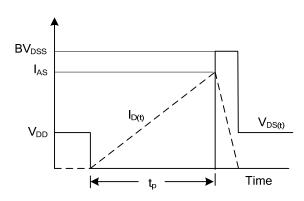




Gate Charge Test Circuit

Gate Charge Waveform

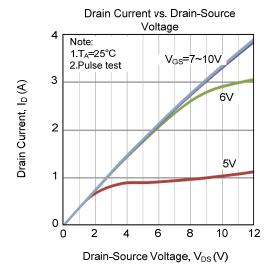


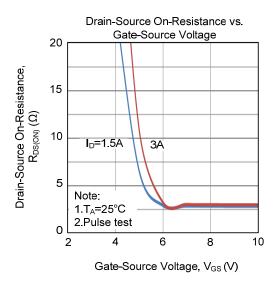


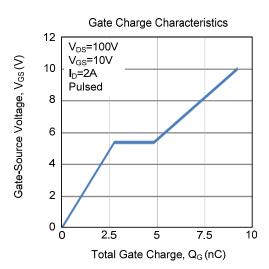
Unclamped Inductive Switching Test Circuit

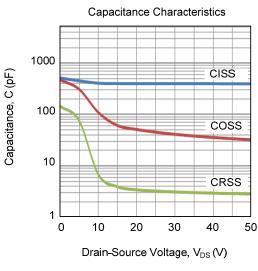
Unclamped Inductive Switching Waveforms

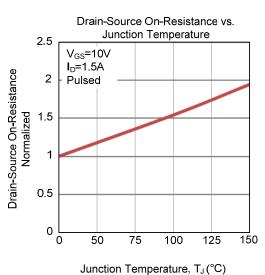
■ TYPICAL CHARACTERISTICS

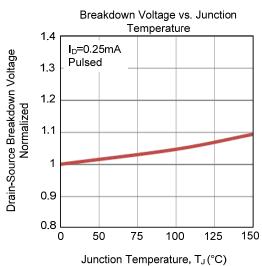




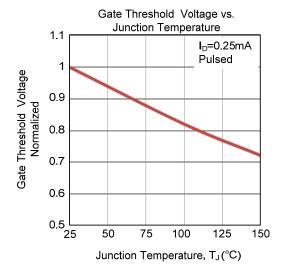


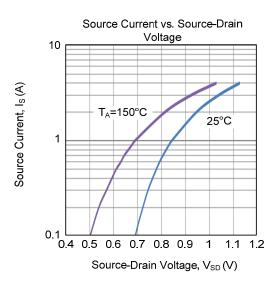


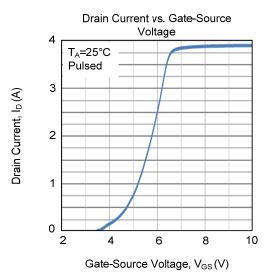


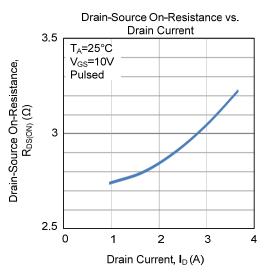


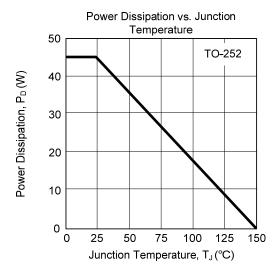
■ TYPICAL CHARACTERISTICS (Cont.)

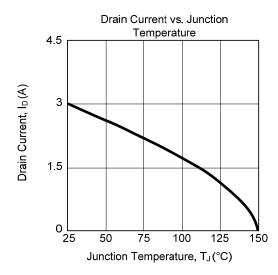




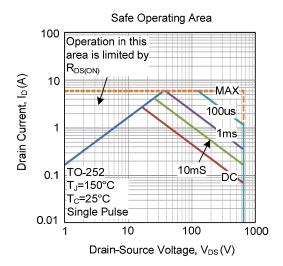








■ TYPICAL CHARACTERISTICS (Cont.)



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